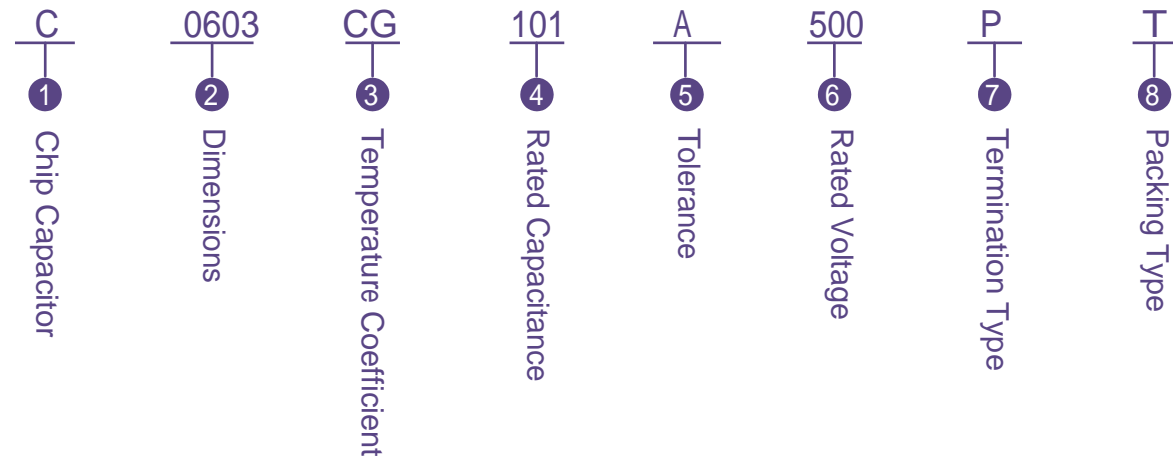


EIA NPO Dielectric Non-Magnetic Multilayer Ceramic Capacitors

Product Features

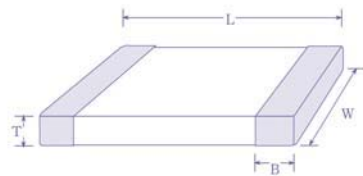
Non-Magnetic, Suitable for MRT

Part Numbering



Chip Capacitor

%Dimensions



Type	Dimensions (Unit: mm)				
	W	T(max)	B(min)	B (max)	
0603	1.6±0.1	0.8±0.1	0.8±0.1	0.20	0.50
0805	2.0±0.2	1.2±0.2	1.40	0.25	0.70

Temperature Coefficient

Code(ETA)	Temperature Coefficients	Operating Temperature Range
CG(C0G)	0±30ppm1	-55°C +125°C



Rated Capacitance

Code	Capacitance
1R5	1.5pF
101	100pF

Rated voltage

Code	Rated Voltage(DC)
500	50V
101	100V
201	200V

Packing Type

Code	Packing Type
T	Tape carrier packing
B	Bulk packing in a bag

Tolerance

Code	Tolerance	Capacitance Range
B	±0.1pF	810pF
C	±0.25pF	
D	±0.5pF	
F	±1%	910pF
G	±2%	
J	±5%	

Termination Type

Code	Termination Type
P	Non-magnetic Copper Plated 100% Sn (RoHS)

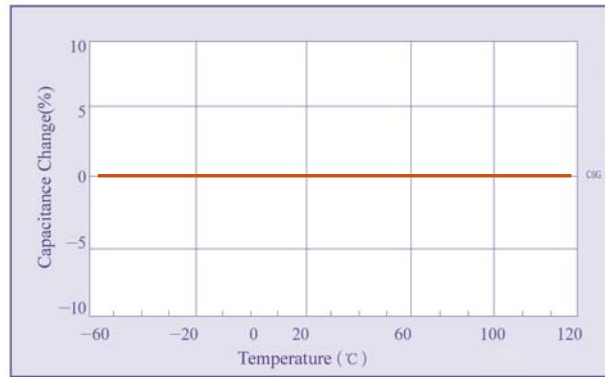
Rated Capacitance Range Table (Unit: pF)

T.C.	Dimensions	Volt.	Capacitance Range (pF)			
			0.1	100	200	220
CG	0603	50V	0.1	100		
	0805	50V	0.2			220
	0805	100V	0.2	100		

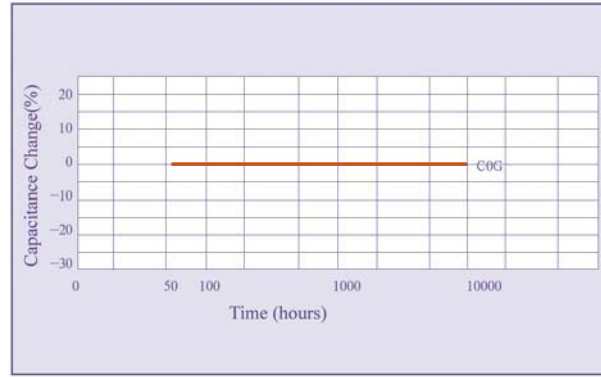


Characteristics Curve

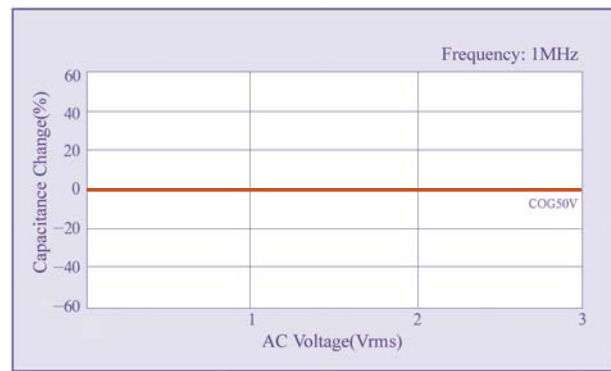
Capacitance vs Temperature



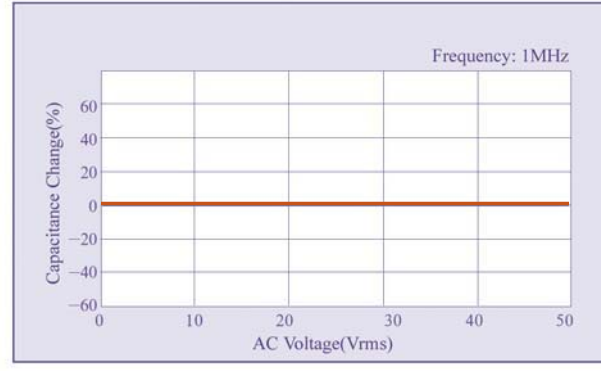
Capacitance Change vs Aging



Capacitance Change vs AC Voltage



Capacitance Change vs DC Voltage

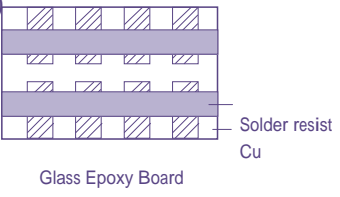
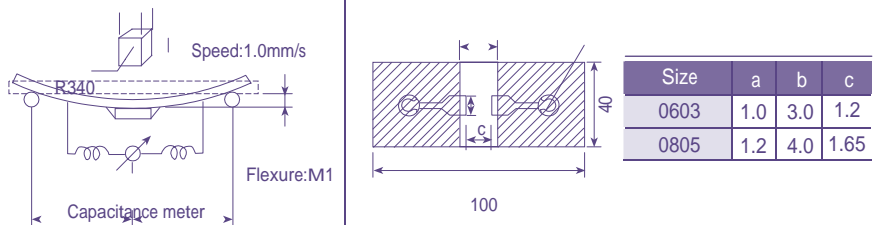


Specifications and Test Methods

No.	Item	Specification	Test Method												
1	Operating Temperature Range	-55° ; +125°													
>	Rated Voltage	See the previous pages	The rated voltage means the maximum direct voltage or peak value of pulse voltage which may be applied continuously to a capacitor.												
?	Appearance	No defects or abnormality	Visual inspection												
@	Dimensions	See the previous pages	Callipers inspection												
A	Dielectric Strength	No defects or abnormality	No failure shall be observed when 250% of the rated voltage is applied between the terminations for 1 to 5 seconds, provided the charge/discharge current is less than 50mA.												
B	Insulation Resistance	More than 1000000MΩ	The insulation resistance shall be measured with the rated voltage at 25°, 75 RH and within 1 minute of charging.												
C	Capacitance	Within the specified tolerance	The capacitance/Q shall be measured at 25° with the frequency and voltage shown in the table.												
D	Q	Q is not less than 1000	<table border="1"> <thead> <tr> <th>Frequency</th> <th>Voltage</th> </tr> </thead> <tbody> <tr> <td>1±0.1MHz</td> <td>1±0.2Vrms</td> </tr> </tbody> </table>	Frequency	Voltage	1±0.1MHz	1±0.2Vrms								
Frequency	Voltage														
1±0.1MHz	1±0.2Vrms														
E	Temperature Coefficient	See the previous pages capacitance drift: Within 0.3% or 0.05pF (whichever is large)	<p>The temperature cycling sequential is from step 1 through 5. The temperature coefficient shall be within the specified tolerance for the temperature coefficient. The temperature coefficient equal $I(C_i - C_3)/C_3 / (T_i - T_3)$. The capacitance drift is calculated by dividing the differences between the maximum and minimum measured values in the step 1,3 and 5 by the capacitance value in step 3.</p> <table border="1"> <thead> <tr> <th>Step</th> <th>Temperature</th> </tr> </thead> <tbody> <tr> <td>1</td> <td>25±2°</td> </tr> <tr> <td>2</td> <td>55±3°</td> </tr> <tr> <td>3</td> <td>25±2°</td> </tr> <tr> <td></td> <td>125±3°</td> </tr> <tr> <td>5</td> <td>25±2°</td> </tr> </tbody> </table>	Step	Temperature	1	25±2°	2	55±3°	3	25±2°		125±3°	5	25±2°
Step	Temperature														
1	25±2°														
2	55±3°														
3	25±2°														
	125±3°														
5	25±2°														
10	Adhesive Strength of Termination	No removal of the terminations or other defect shall occur	<p>Solder a capacitor to test jig (glass epoxy board) shown in below fig using a eutectic solder, then apply 10N force in the direction of the arrow. The soldering should be done either by hand iron or using the reflow method and shall be conducted with care so that the soldering is uniform and free of defects such as heat shock.</p>												



Specifications and Test Methods

No.	Item	Specification	Test Method												
11	Appearance	No defect or abnormality	Solder the capacitor to test jig (glass epoxy board) shown in below fig. Soldering should be done either by hand iron or using the reflow method and shall be conducted with care so that the soldering is uniform and free of defects such as heat shock. The capacitor shall be subjected to a simple harmonic motion having a total amplitude of 1.5mm, The frequency being varied uniformly between the approximate limits of 10 and 55Hz. The frequency range, from 10 to 55Hz and return to 10Hz, shall be traversed in approximately 1 minute. This motion shall be applied for a period of 2 hours in each 3 mutually perpendicular directions (total 6 hours)												
	Capacitance	Within the specified tolerance													
	Q	Q91000													
	Vibration Resistance		 <p style="text-align: center;">Glass Epoxy Board</p>												
		No cracking or marking defects shall occur, NC/C810%	<p>Solder the capacitor to the glass epoxy boards shown in below fig. Then apply a force in the direction and measured the capacitance.</p>  <table border="1" style="margin-left: auto; margin-right: auto;"> <thead> <tr> <th>Size</th> <th>a</th> <th>b</th> <th>c</th> </tr> </thead> <tbody> <tr> <td>0603</td> <td>1.0</td> <td>3.0</td> <td>1.2</td> </tr> <tr> <td>0805</td> <td>1.2</td> <td>4.0</td> <td>1.65</td> </tr> </tbody> </table>	Size	a	b	c	0603	1.0	3.0	1.2	0805	1.2	4.0	1.65
Size	a	b	c												
0603	1.0	3.0	1.2												
0805	1.2	4.0	1.65												
13	Solderability of Termination	More than 75% of the terminations is to be soldered evenly and continuously.	Immerse the capacitor first in an ethanol solution of rosin, Preheat at 80° to 120° for 10 to 30 seconds. After preheating, immerse in eutectic solder solution for 2±0.5 seconds at 230±5°.												
14	Resistance to Soldering Heat	Appearance	No marking defects												
		Capacitance Range	Less than ±2.5% or ±0.25pF (Whichever is larger)												
		Q	Q91000												
		Insulation Resistance	More than 100000M												
			Preheat capacitor at 120° to 200° for 1 minutes, Then immerse the capacitor in an eutectic solder at 260° to 265° for 10±1 seconds, the immersed depth is 10mm. Set it for 24±2 hours at room.												



Specifications and Test Methods

No.	Item	Specification	Test Method															
15	Appearance	No marking defects	Fix the capacitor to the supporting jig in the same manner and under the same conditions as (11). Perform the five cycles according to the four heat treatments listed in the following table. Set it for 24±2 hours at room temperature.															
	Capacitance Range	Less than ±1% or ±0.25pF (Whichever is larger)																
	Q	Q91000																
	Insulation Resistance	More than 100000MQ																
	Temperature Cycle		<table border="1" style="margin-left: auto; margin-right: auto;"> <thead> <tr> <th>Step</th> <th>Temperature(°)</th> <th>Time(minutes)</th> </tr> </thead> <tbody> <tr> <td>1</td> <td>Min.operating temp. -3 to 0</td> <td>30±3</td> </tr> <tr> <td>2</td> <td>Room temperature</td> <td>2 to 3</td> </tr> <tr> <td>3</td> <td>Max.operating temp. -3 to 0</td> <td>30±3</td> </tr> <tr> <td>4</td> <td>Room temperature</td> <td>2 to 3</td> </tr> </tbody> </table>	Step	Temperature(°)	Time(minutes)	1	Min.operating temp. -3 to 0	30±3	2	Room temperature	2 to 3	3	Max.operating temp. -3 to 0	30±3	4	Room temperature	2 to 3
Step	Temperature(°)	Time(minutes)																
1	Min.operating temp. -3 to 0	30±3																
2	Room temperature	2 to 3																
3	Max.operating temp. -3 to 0	30±3																
4	Room temperature	2 to 3																
16	Appearance	No marking defects	Sit the capacitor at 40±2° and 90% to 95% humidity for 500±12 hours. Remove and let sit for 24±2 hours at room temperature, then measure.															
	Capacitance Range	Less than ±5% or ±0.5pF (Whichever is larger)																
	Q	Q91000																
	Humidity Steady State																	
	Resistance																	
	Humidity Load	Appearance	No marking defects															
		Capacitance Range	Less than ±5% or ±0.5pF (Whichever is larger)															
		Q	Q91000															
		Insulation Resistance	More than 100000MQ															
			Apply the rated voltage at 40±2° and 90% to 95% humidity for 500±12 hours. temperature, then measure. The charge/discharge current is less than 50mA.															
18	High Temperature Load	Appearance	No marking defects															
		Capacitance Range	Less than ±2.5% or ±0.25pF (Whichever is larger)															
		Q	Q91000															
		Insulation Resistance	More than 100000MQ															
			Apply a voltage of 150% of the rated voltage for 1000±12 hours at 125±3°, and set it for 24±2 hours at room temperature, then measure. The charge/discharge current is less than 50mA.															

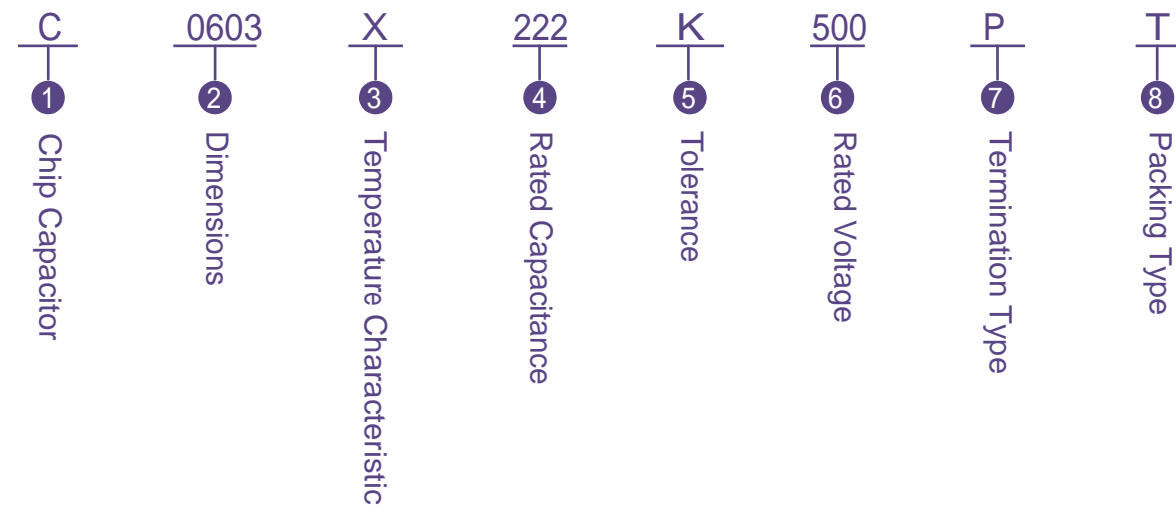


EIA X7R Dielectric Non-Magnetic Multilayer Ceramic Capacitors

Product Features

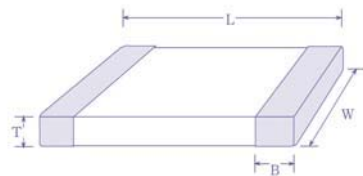
Non-Magnetic, Suitable for MRI

Part Numbering



Chip Capacitor

%Dimensions



Type	Dimensions (Unit: mm)				
	L	W	T(max)	B(min)	B (max)
0603	1.6±0.1	0.8±0.1	0.8±0.1	0.20	0.50
0805	2.0±0.2	1.2±0.2	1.40	0.25	0.70

Temperature Characteristics

Code(EIA)	Temperature Characteristics	Operating Temperature Range
X(X7R)	±15%	/55° 0125°



Rated Capacitance

Code	Capacitance
102	1000pF
222	2200pF

Tolerance

Code	Tolerance
J	±5%
K	±10%
M	±20%

Rated voltage

Code	Rated Voltage(DC)
501	500V

Termination Type

Code	Termination Type
P	Non-magnetic Copper Plated 100% Sn(RoHS)

Packing Type

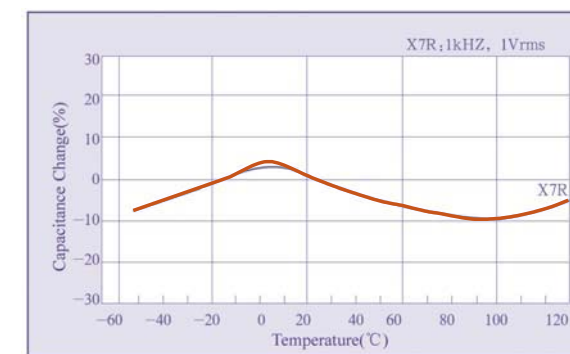
Code	Packing Type
T	Tape carrier packing
B	Bulk packing in a bag

Rated Capacitance Range Table (Unit: pF)

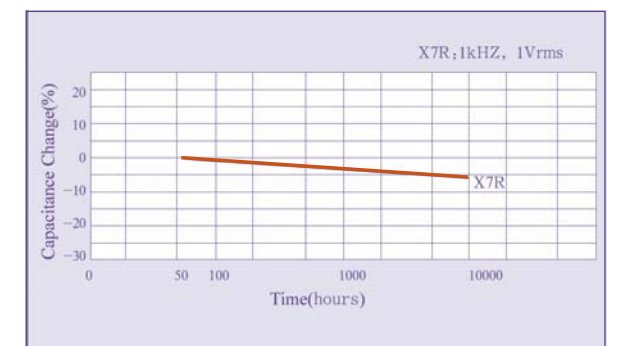
Dimensions	Volt.	Capacitance Range (pF)				
		0.5	10	100	1000	10000
0603	50V			1000	4700	
0805	50V			1000	22000	

Characteristics Curve


Capacitance vs Temperature



Capacitance Change vs Aging

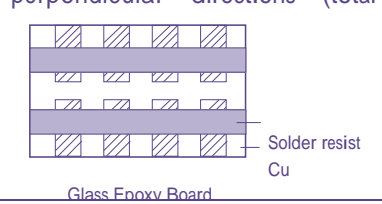
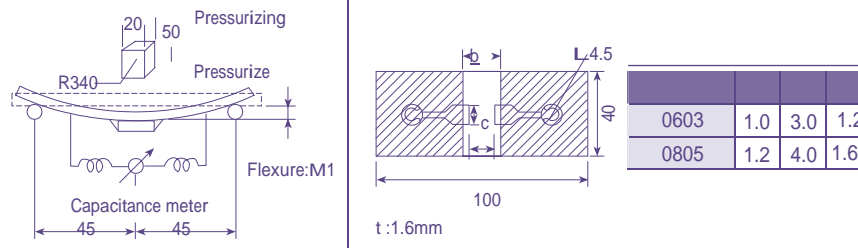


Specifications and Test Methods

No.	Item	Specification	Test Method						
1	Operating Temperature Range	-55 ^o ~ +125 ^o							
2	Rated Voltage	50V	The rated voltage means the maximum direct voltage or peak value of pulse voltage which may be applied continuously to a capacitor.						
3	Appearance	No defects or abnormality	Visual inspection						
4	Dimensions	See the previous pages	Callipers inspection						
5	Dielectric Strength	No defect or abnormality	No failure shall be observed when the given coefficient of the rated voltage is applied between the terminations for 1 to 5 seconds, provided the charge/discharge current is less than 50mA.						
6	Insulation Resistance	More than 100000MQ	The insulation resistance shall be measured with the testing voltage at normal temperature and humidity and within 2 minute of charging.						
7	Capacitance	Within the specified tolerance	The capacitance Q/D.F. shall be measured at 25 ^o with the frequency and voltage shown in the table.						
8	D.F. Dissipation Factor	D.F. 2.5%							
			<table border="1"> <thead> <tr> <th></th> <th>Frequency</th> <th>Voltage</th> </tr> </thead> <tbody> <tr> <td>X7R</td> <td>1±0.1KHz</td> <td>1±0.2Vrms</td> </tr> </tbody> </table>		Frequency	Voltage	X7R	1±0.1KHz	1±0.2Vrms
	Frequency	Voltage							
X7R	1±0.1KHz	1±0.2Vrms							
E	Temperature Characteristics	15%	Refer to the test methods of general ceramic chip capacitors.						
10	Adhesive Strength of Termination	No removal of the terminations or other defect shall occur	<p>Solder a capacitor to test jig (glass epoxy board) shown in below fig using an eutectic solder, Then apply 10N force in the direction of the arrow.</p> <p>The soldering should be done either by hand iron or using the reflow method and shall be conducted with care so that the soldering is uniform and free of defects such as heat shock.</p>  <p>10Newton Glass Epoxy Resin Board</p>						



Specifications and Test Methods

No.	Item	Specification	Test Method								
11	Appearance	No defect or abnormality	Solder the capacitor to test jig (glass epoxy board) shown in below fig. Soldering should be done either by hand iron or using the reflow method and shall be conducted with care so that the soldering is uniform and free of defects such as heat shock. The capacitor shall be subjected to a simple harmonic motion having a total amplitude of 1.5mm, The frequency being varied uniformly between the approximate limits of 10 and 55Hz. The frequency range, from 10 to 55Hz and return to 10Hz, shall be traversed in approximately 1 minute. This motion shall be applied for a period of 2 hours in each 3 mutually perpendicular directions (total 6 hours)								
	Capacitance	Within the specified tolerance									
	D.F.	D.F. 2.5%									
			 <p>Solder resist Cu Glass Epoxy Board</p>								
12	Deflection	No cracking or marking defects shall occur, A/C/8 10%	<p>Solder the capacitor to test jig (glass epoxy board) shown in below fig. Then apply a force in the direction shown in below fig.</p>  <table border="1"> <tbody> <tr> <td>0603</td> <td>1.0</td> <td>3.0</td> <td>1.2</td> </tr> <tr> <td>0805</td> <td>1.2</td> <td>4.0</td> <td>1.65</td> </tr> </tbody> </table> <p>t : 1.6mm</p>	0603	1.0	3.0	1.2	0805	1.2	4.0	1.65
0603	1.0	3.0	1.2								
0805	1.2	4.0	1.65								
13	Solderability of Termination	More than 75% of the terminations is to be soldered evenly and continuously.	Immerse the capacitor first in an ethanol solution of rosin, Preheat at 80 ^o to 120 ^o for 10 to 30 seconds. After preheating, immerse in eutectic solder solution for 2±0.5 seconds at 230±5 ^o .								
14	Resistance to Soldering Heat	Appearance	No marking defects								
		Capacitance Range	10%								
		D.F	D.F. 2.5%								
		Insulation Resistance	I.R: More than 10000 meg ohms								



Specifications and Test Methods

No.	Item	Specification	Test Method															
15	Temperature Cycle	Appearance	No marking defects															
		Capacitance Range	10%															
		D.F	D.F 2.5%															
		Insulation Resistance	More than 10000 meg ohms															
			<table border="1"> <thead> <tr> <th>Step</th> <th>Temperature(°C)</th> <th>Time(minutes)</th> </tr> </thead> <tbody> <tr> <td>1</td> <td>Min.operating temp. -3 to 0</td> <td>30±3</td> </tr> <tr> <td>2</td> <td>Room temperature</td> <td>2 to 3</td> </tr> <tr> <td>3</td> <td>Max.operating temp. -3 to 0</td> <td>30±3</td> </tr> <tr> <td>4</td> <td>Room temperature</td> <td>2 to 3</td> </tr> </tbody> </table>	Step	Temperature(°C)	Time(minutes)	1	Min.operating temp. -3 to 0	30±3	2	Room temperature	2 to 3	3	Max.operating temp. -3 to 0	30±3	4	Room temperature	2 to 3
Step	Temperature(°C)	Time(minutes)																
1	Min.operating temp. -3 to 0	30±3																
2	Room temperature	2 to 3																
3	Max.operating temp. -3 to 0	30±3																
4	Room temperature	2 to 3																
16	Humidity Steady State	Appearance	No defect or abnormality															
		Capacitance Range	10%															
		D.F	D.F 2.5%															
		Insulation Resistance	More than 1000 meg ohms															
			Sit the capacitor at $40\pm 2^{\circ}$ and 90% to 95% humidity for 500 ± 12 hours. Remove and let sit for 48 ± 2 hours at room temperature, then measure.															
17	High Temperature Load	Appearance	No marking defects															
		Capacitance Range	10%															
		D.F	D.F 2.5%															
		Insulation Resistance	More than 1000 meg ohms															
			Apply a DC voltage of 150% of the rated voltage for 1000 hours at the maximum operating temperature, and set it for 48 hours at room temperature, then measure. The charge/discharge current is less than 50mA.															


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